ON Semiconductor®



Title of Change:	Qualification of AFSM (Aizu Fujitsu Semiconductor Manufacturing) as an additional Wafer Fab facility for ONC25 Technology		
Proposed first ship date:	28 September 2017 or earlier upon customer approval		
Contact information:	Contact your local ON Semiconductor Sales Office or <shannon.riggs@onsemi.com></shannon.riggs@onsemi.com>		
Samples:	Contact your local ON Semiconductor Sales Office		
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or <shannon.riggs@onsemi.com>.</shannon.riggs@onsemi.com>		
Type of notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 90 days prior to implementation of the change. ON Semiconductor will consider this change accepted, unless an inquiry is made in writing within 30 days of delivery of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>		
Change Part Identification:	Shipments made after work week 30, 2017 may contain die sourced from either AFSM Fab or ON Semiconductor fab in Gresham, Oregon. The product date code will indicate the work week of manufacturing and the product labels will contain the wafer source indicator.		
Change category:	Wafer Fab Change Assembly Change Test Change Other		
Change Sub-Category(s): Manufacturing Site Change/ Manufacturing Process Char	Addition Addition Addition Product specific change Other:		
Sites Affected:	oplicable ON Semiconductor site(s) : External Foundry/Subcon site(s) AFSM (Aizu Fujitsu Semiconductor Manufacturing) Wafer Fab, Aizuwakatmatsu, Japan		
Description and Purpose:			
The AFSM (Aizu Fujitsu Semicond CMOS process. The exact same process technold USA. Tool sets are different but t	uctor Manufacturing) Wafer Fab located in Aizuwakamatsu, Japan has been qualified to process the ONC25 gy has been transferred as is currently running in the ON Semiconductor wafer fab located at Gresham, Oregon, he exact same masking layers and steps are being used in the AFSM Fab.		
This is a capacity expansion to su processed at either wafer fab in t	pplement the existing ON Semiconductor wafer fab. The parts being qualified are dual sourced and may be he future depending on capacity requirements.		

Additional part families will be announced on future PCNs once qualifications of those parts are completed.

This PCN will apply to future Regulator output voltage versions of the part families listed below.



Reliability Data Summary:

QV DEVICE NAME

NCP17	AVBXVXXX12G			
Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 100 % max rated <u>Vcc</u>	1008 hrs	0/160
ELFR	JA108	Ta=125°C, 100 % max rated Vcc	48 hrs	0/2400
HTSL	JA103	Ta=150°C	1008 hrs	0/240
тс	JESD22-A104	Ta= -65°C to +150°C	500 <u>sys</u>	0/270
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	264 hrs	0/270
UHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/240
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		PASS
RSH	JESD22-B106	Ta = 265C, 10 sec		0/90
ED	Electrical Distribution	Critical parameters		CPK>1.67, Pass
BPS	MILSTD883 Method 2011	Cond C.		CPK>1.67, Pass
SAT	J-STD-020 JESD-A113			Pass
ESD	CDM JS002		1kV	Pass
ESD	HBM JS001		2kV	Pass
LU	JESD78	Class II	+/-100ma	Pass

QV DEVICE NAME NCP160/1BFCSxxT2G, NCP160/1BFCTxxT2G, NCP160/1A/BMXxxxTBG

Test	Specification	Condition	Interval	Results
HTOL	JESD22-A108	Ta=125°C, 100 % max rated ¥cc	1008 hrs	0/336
HTSL	JA103	Ta=150°C	1008 hrs	0/251
тс	JESD22-A104	Ta= -40°C to +150°C	1000 _{SXS}	0/334
HAST	JESD22-A110	130°C, 85% RH, 18.8psig, bias	96 hrs	0/336
UHAST	JESD22-A118	130°C, 85% RH, 18.8psig, unbiased	96 hrs	0/336
PC	J-STD-020 JESD-A113	MSL 1 @ 260 °C		Pass
ED	Electrical Distribution	Critical parameters		CPK>1.67, Pass
ESD	HBM JS001		2kV	Pass
LU	JESD78		+/-100mA	Pass

Electrical Characteristic Summary:

There are no changes to any electrical parameters. All data sheet specifications remain the same.



	Part Number		Qualification Vehicle
ICP120AMX080TCG	NCP133AMX110TCG	NCP170BMX120TCG	
ICP120AMX105TCG	NCP133AMX115TCG	NCP170BMX135TCG	
ICP120AMX110TCG	NCP133AMX120TCG	NCP170BMX150TCG	
ICP120AMX115TCG	NCP133AMX125TCG	NCP170BMX250TCG	
ICP120AMX120TCG	NCP133AMX130TCG	NCP170BMX280TCG	
ICP120AMX150TCG	NCP133AMX150TCG	NCP170BMX285TCG	
ICP120AMX180TCG	NCP133AMX180TCG	NCP170BMX300TCG	
ICP120AMX210TCG	NCP133AMXADJTCG	NCP170BMX310TCG	
ICP120BMX080TCG	NCP133BMXADJTCG	NCP170BXV120T2G	
ICP120BMX105TCG	NCP134AMX100TCG	NCP170BXV135T2G	
ICP120BMX110TCG	NCP134AMX105TCG	NCP170BXV150T2G	
ICP120BMX115TCG	NCP134AMX110TCG	NCP170BXV180T2G	
ICP120BMX120TCG	NCP134AMX120TCG	NCP170BXV250T2G	
ICP120BMX150TCG	NCP137AFCTADJT2G	NCP170BXV280T2G	
ICP120BMX180TCG	NCP137AFCTCADJT2G	NCP170BXV300T2G	
ICP120BMX210TCG	NCP170AMX120TCG	NCP170BXV310T2G	
ICP130AMX080TCG	NCP170AMX135TCG	NCP170BXV330T2G	
ICP130AMX090TCG	NCP170AMX150TCG	NCP186AMX120TAG	NCP170A/BXVxxxT2G
ICP130AMX100TCG	NCP170AMX180TCG	NCP186AMX175TAG	NCP160/1BFCSXXX12G
ICP130AMX105TCG	NCP170AMX190TCG	NCP186AMX180TAG	NCP160/1A/BMXxxxTBG
ICP130AMX110TCG	NCP170AMX250TCG	NCP186AMX185TAG	
ICP130AMX115TCG	NCP170AMX280TCG	NCP186AMX250TAG	
ICP130AMX120TCG	NCP170AMX285TCG	NCP186AMX280TAG	
ICP130AMX150TCG	NCP170AMX300TCG	NCP186AMX300TAG	
ICP130BMX080TCG	NCP170AMX310TCG	NCP186AMX330TAG	
ICP130BMX090TCG	NCP170AMX330TCG	NCP186AMX350TAG	
ICP130BMX100TCG	NCP170AXV120T2G	NCP186AMX390TAG	
ICP130BMX110TCG	NCP170AXV135T2G	NCP186BMX120TAG	
ICP130BMX115TCG	NCP170AXV150T2G	NCP186BMX175TAG	
ICP130BMX120TCG	NCP170AXV180T2G	NCP186BMX180TAG	
ICP130BMX150TCG	NCP170AXV210T2G	NCP186BMX185TAG	
ICP130BMX180TCG	NCP170AXV250T2G	NCP186BMX250TAG	
ICP130BMX210TCG	NCP170AXV280T2G	NCP186BMX280TAG	
ICP133AMX090TCG	NCP170AXV300T2G	NCP186BMX300TAG	
ICP133AMX100TCG	NCP170AXV310T2G	NCP186BMX330TAG	
ICP133AMX105TCG	NCP170AXV330T2G	NCP186BMX350TAG	
		NCP186BMX390TAG	